TOSHIBA Schottky Barrier Diode

CRS15

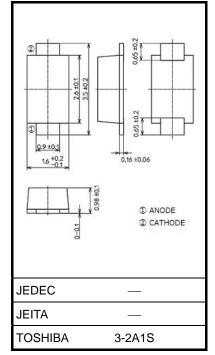
Switching Mode Power Supply Applications Portable Equipment Battery Applications

- Repetitive peak reverse voltage : VRRM = 30 V
- Forward current $: I_F(DC) = 3 A$
- Peak forward voltage $: V_{FM} = 0.52 V (max)$
- Small, thin package suitable for high-density board assembly Toshiba Nickname: "S-FLATTM"

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Repetitive peak reverse voltage	Vrrm	30	V
Forward current (DC)	IF (DC)	3 (Note 1)	А
Non-repetitive peak forward surge current	IFSM	30 (50 Hz)	А
Junction temperature	Тј	-40 to 150	°C
Storage temperature	T _{stg}	-40 to 150	°C

Note 1: Ta = 69°C : Device mounted on a ceramic board



Weight: 0.013 g (typ.)

Note 2: Using continuously under heavy loads (e.g. the application of

high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Peak forward voltage	VFM (1)	IFM = 0.1 A (pulse test)		0.35	_		
	VFM (2)	IFM = 1 A (pulse test)	_	0.415	_	V	
	VFM (3)	IFM = 3 A (pulse test)	_	0.47	0.52		
Repetitive peak reverse current	I _{RRM} (1)	V _{RRM} = 5 V (pulse test)	_	0.8	_	μА	
	I _{RRM} (2)	V _{RRM} = 30 V (pulse test)	_	10	50		
Junction capacitance	Cj	$V_R = 10 V$, f = 1 MHz	_	90	_	pF	
Thermal resistance (junction to ambient)	Rth (j-a)	$\begin{array}{llllllllllllllllllllllllllllllllllll$	_		70	°C/W	
		Device mounted on a glass-epoxy board board size : 50 mm × 50 mm soldering land size : 6 mm × 6 mm board thickness : 1.6 mm	_	_	140		
Thermal resistance (junction to lead)	R _{th} (j-ł)		_		20	°C/W	

Start of commercial production 2008-08

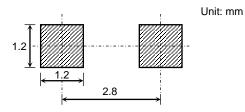
Unit: mm

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Marking

larking		Cathode mark and Lot code
Abbreviation Code	Part No.	
SE	CRS15	SE ← Part No. (or abbreviation code)

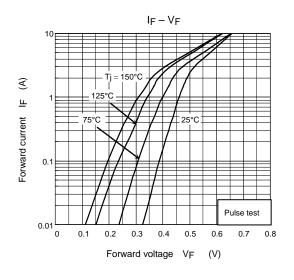
Land pattern dimensions for reference only

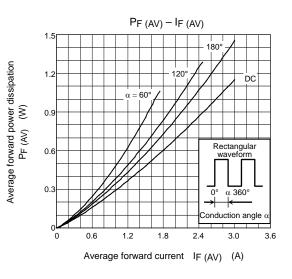


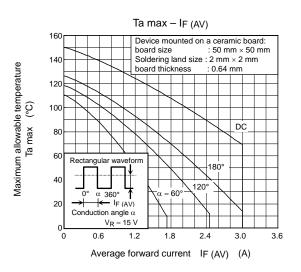
Handling Precaution

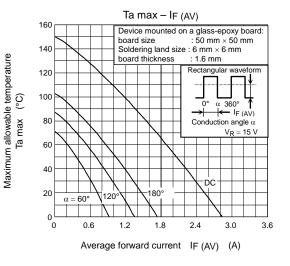
- Schottky barrier diodes have reverse current characteristic compared to other diodes. There is a possibility SBD may cause thermal runaway when it is used under high temperature or high voltage. Please take forward and reverse loss into consideration during design.
- 2) The absolute maximum ratings of a semiconductor device are a set of ratings that must not be exceeded, even for a moment. Do not exceed any of these ratings. The following are the general derating methods that we recommend when you design a circuit with a device.
 - VRRM: Use this rating with reference to the above. VRRM has a temperature coefficient of 0.1%/°C. Take this temperature coefficient into account designing a device at low temperature.
 - $IF(AV) \ \text{and} \ IF(DC) \hbox{: We recommend that the worst case current be no greater than 80\% of the absolute maximum rating of IF(AV) and T_j be below 120°C. When using this device, take the margin into consideration by using an allowable Ta max-IF(AV) curve.}$
 - IFSM: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which seldom occurs during the lifespan of the device.
 - $T_{j} : \qquad \text{Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a T_{j} of below 120^{\circ}\text{C}.$
- 3) Thermal resistance between junction and ambient fluctuates depending on the device's mounting condition. When using a device, design a circuit board and a soldering land size to match the appropriate thermal resistance value.
- 4) For other design considerations, see the Toshiba website.

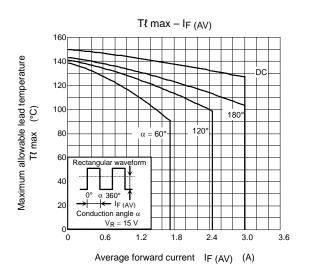
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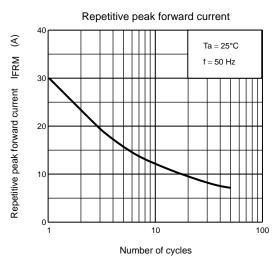




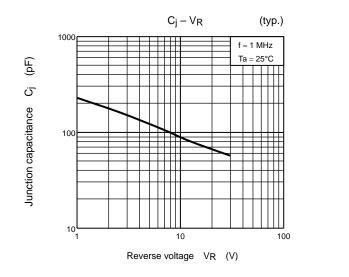


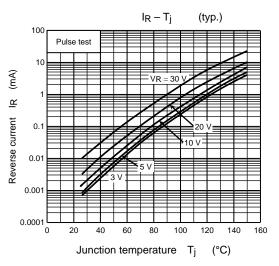


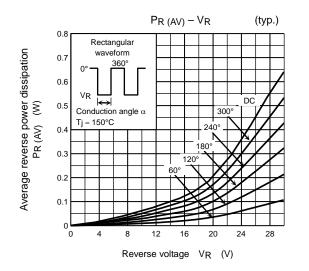


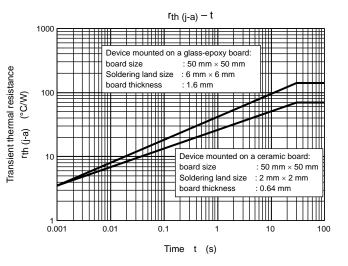


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